

09-15-2004



To the Director of the U.S. Patents and

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102835672

9-13-04

1. Name of conveying party(ies):

- 1. Kimio SAKAI
- 2. Seigo ICHIKAWA
- 3. Akihisa KIKUYA

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other

Execution Date: 1. September 8, 2004 2. September 6, 2004
3. September 6, 2004

Name and address of receiving party(ies):

Name: MGE Engineering Corporation
 Internal Address:
 Street Address: Oaza Imojiya 150
 Chikuma-shi, Nagano-ken, Japan

Additional name(s) & address(es) attached? Yes No

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FINANCE SECTION

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the filing date of the application is February 19, 2004

A. Patent Application No.(s)

10/783,488

B. Patent No.(s)

I hereby certify that this correspondence is being deposited with the United States Postal Services as First Class Mail in an envelope addressed to: Director of the U.S. Patents & Trademarks Office, Mail Stop Assignment Recordation Services, P.O. Box 1450, Alexandria, VA 22313-1450, on September 9, 2004

Dated: September 9, 2004

C. Bruce Hamburg
22,389

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: C. Bruce Hamburg, Esq.
 Internal Address: Jordan and Hamburg LLP
Chanin Building
Suite 4000
 Street Address: 122 East 42nd Street
 City: New York State: New York Zip: 10168

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$40.00

- Enclosed
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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

C. Bruce Hamburg, Esq.
Name of Person Signing

Signature

September 9, 2004
Date

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U.S. National Stage Application

ASSIGNMENT

For value received, I/we, (1) Kimio SAKAI
(2) Seigo ICHIKAWA
(3) Akihisa KIKUYA

residing respectively at (1) Nakane 3662-16, Hitachinaka-shi, Ibaraki-ken, Japan
(2) Yashiro 242-8, Chikuma-shi, Nagano-ken, Japan
(3) Grandage Okazawa 101,
Kawanakajimamachihara 217-6, Nagano-shi,
Nagano-ken, Japan

hereby sell, assign, and transfer to MGE ENGINEERING CORPORATION
Japan
a corporation existing under the laws of Japan
located at Oaza Imojiya 150, Chikuma-shi, Nagano-ken, Japan

and its successors, assigns, and legal representatives, the entire right, title, and interest for all countries including the United States of America, in and to certain inventions relating to METHOD FOR TREATING ETA-CONTAINING WASTE WATER

described in an application for Letters Patent of the United States, executed by me/us on this date, and all patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and Trademarks to issue all patents on said improvements or resulting therefrom to said Company as assignee of the entire interest, and covenant that I/we have full right so to do, and agree that I/we will communicate to said Company or its representatives any facts known to me/us respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Company, its successors, assigns, and nominees, to obtain and enforce proper protection for said invention in the United States.

Signature Kimio Sakai Date September 8, 2004

Signature Seigo Ichikawa Date September 6, 2004

Signature Akihisa Kikuya Date September 6, 2004